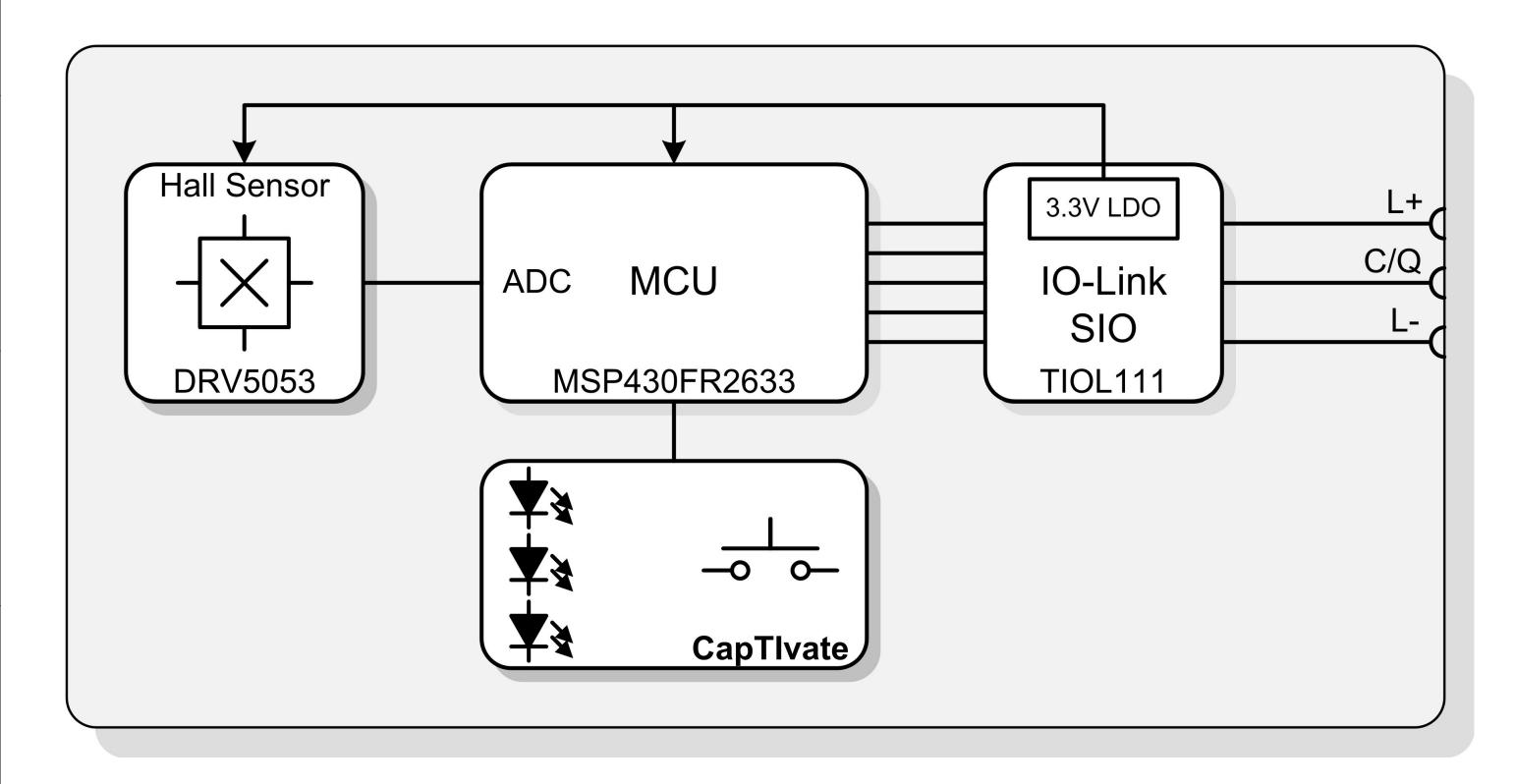
**Revision History** ECN# Approved by



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Orderable: N/A

TiD #: TiDA-01239

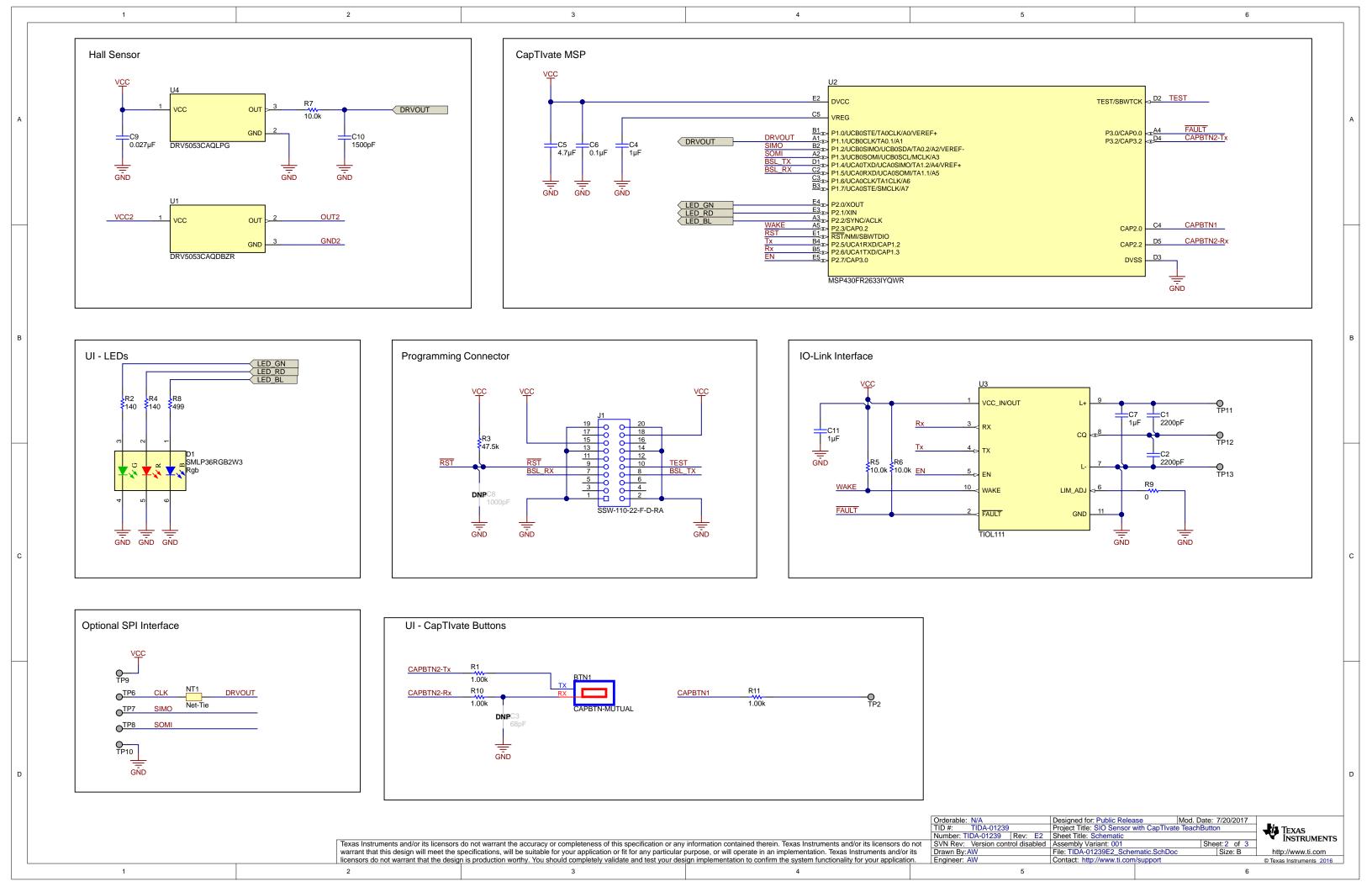
Project Title: SIO Sensor with CapTivate TeachButton

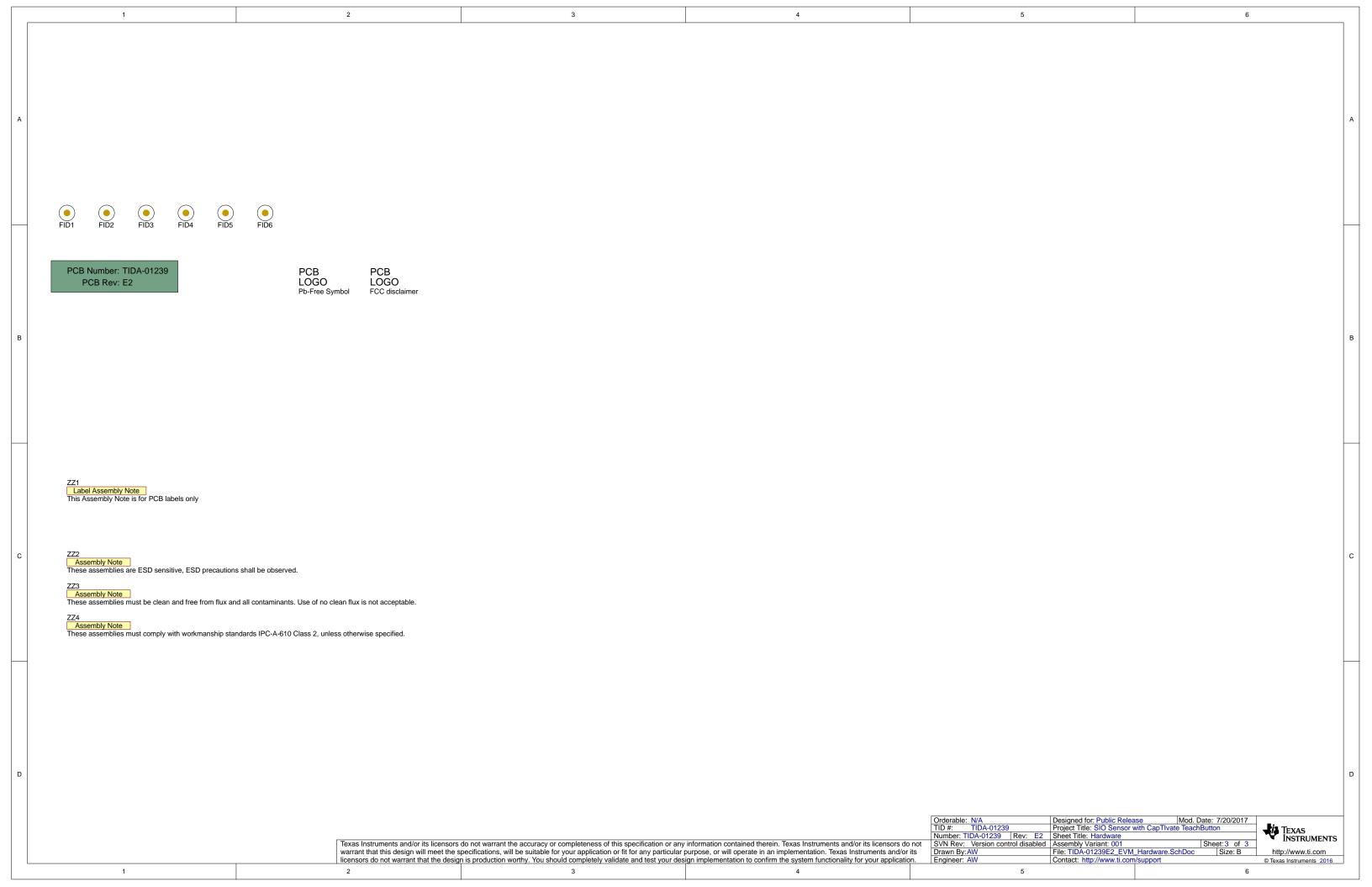
Number: TiDA-01239 | Rev: E2 | Sheet Title: Block Diagram

SVN Rev: Version control disabled | Assembly Variant: 001 | Sheet: 1 of 3 Drawn By: AW File: TIDA-01239E2\_CoverSheet.SchDoc

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